

- Sourced from process 47.
- See MPSH11 for characteristics.

1. Base 2. Emitter 3. Collector

MPSH34

# Absolute Maximum Ratings T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter		Value	Units
V <sub>CEO</sub>	Collector-Emitter Voltage		40	V
V <sub>CBO</sub>	Collector-Base Voltage		40	V
V <sub>EBO</sub>	Emitter-Base Voltage		4.0	V
I <sub>C</sub>	Collector current	- Continuous	50	mA
T <sub>J</sub> , T <sub>stg</sub>	Junction and Storage Temperature		-55 ~ +150	°C

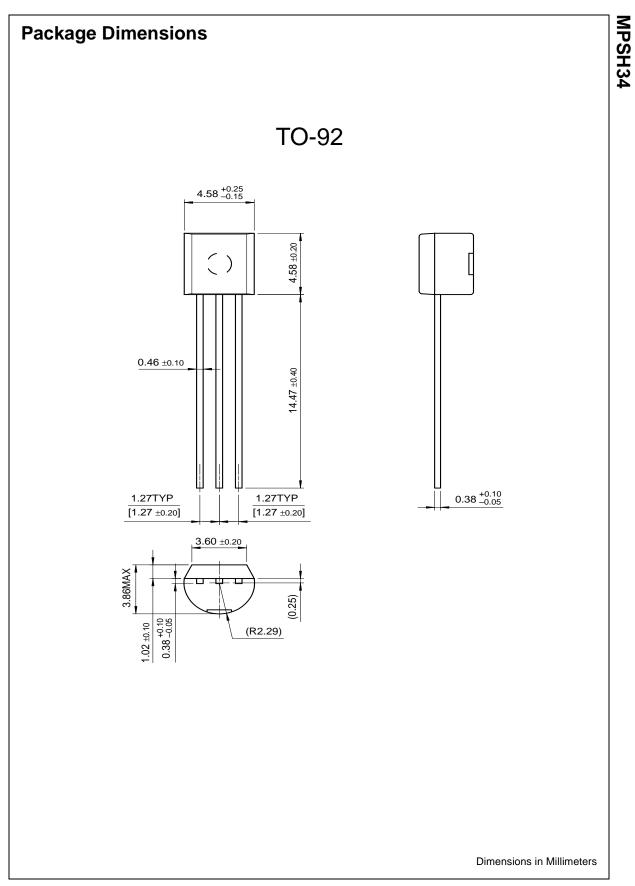
## Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Characte	eristics		•	•	
V <sub>(BR)CEO</sub>	Collector-Emitter Sustaining Voltage *	$I_{\rm C} = 1.0 {\rm mA}, I_{\rm B} = 0$	40		V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_{\rm C} = 100 \mu {\rm A}, I_{\rm E} = 0$	40		
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_{\rm E} = 10\mu A, I_{\rm C} = 0$	4.0		VV
I <sub>CBO</sub>	Collector Cutoff Current	$V_{CB} = 30V, I_E = 0$		50	nA
On Characte	eristics				
h <sub>FE</sub>	DC Current Gain	$V_{CE} = 2.0V, I_C = 20mA$ $V_{CE} = 15V, I_C = 7.0mA$	15 40		
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 7.0mA, I <sub>B</sub> = 2.0mA		0.5	V
V <sub>BE(on)</sub>	Base-Emitter On Voltage	V <sub>CE</sub> = 15V, I <sub>C</sub> = 7.0mA		0.95	V
Small Signa	I Characteristics		•	•	
f <sub>T</sub>	Current Gain Bandwidth Product	I <sub>C</sub> =15mA, V <sub>CE</sub> = 15V, f = 100MHz	500		MHz
C <sub>cb</sub>	Collector-Base Capacitance	$V_{CB} = 10V, I_{F} = 0, f = 1.0MHz$		0.32	pF

\* Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%

# Thermal Characteristics $T_A=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Max.	Units	
PD	Total Device Dissipation	625	mW	
	Derate above 25°C	5.0	mW/°C	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case	83.3	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	200	°C/W	



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